

54AC/74AC158 • 54ACT/74ACT158 Quad 2-Input Multiplexer

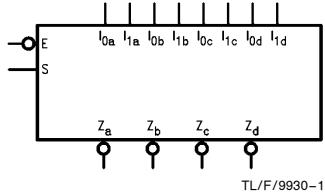
General Description

The 'AC/'ACT158 is a high-speed quad 2-input multiplexer. It selects four bits of data from two sources using the common Select and Enable inputs. The four buffered outputs present the selected data in the inverted form. The 'AC/'ACT158 can also be used as a function generator.

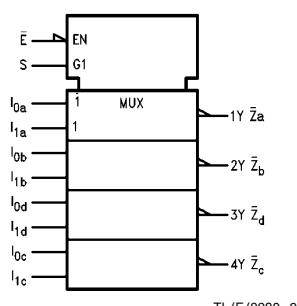
Features

- I_{CC} reduced by 50%
- Outputs source/sink 24 mA
- 'ACT158 has TTL-compatible inputs
- Standard Military Drawing (SMD)
 - 'AC158: 5962-89729
 - 'ACT158: 5962-88755

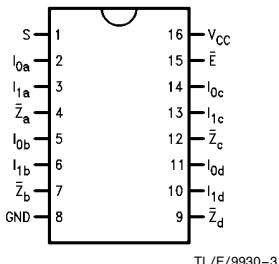
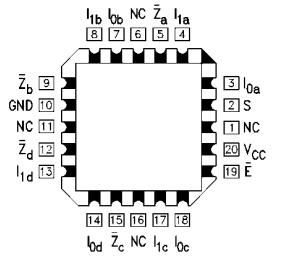
Logic Symbols



IEE/IEC



Connection Diagrams

Pin Assignment
for DIP, Flatpak and SOICPin Assignment
for LCC

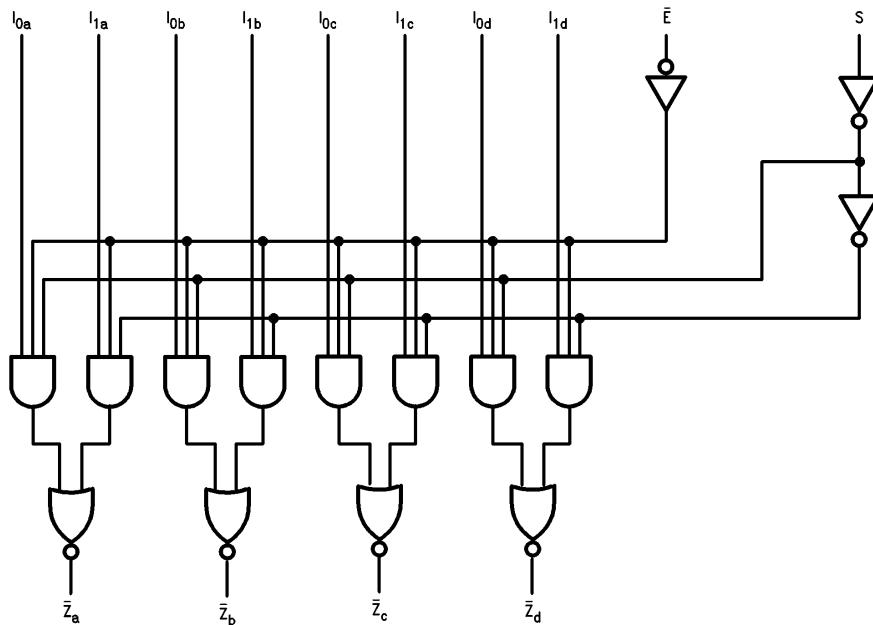
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Functional Description

The 'AC/'ACT158 quad 2-input multiplexer selects four bits of data from two sources under the control of a common Select input (S) and presents the data in inverted form at the four outputs. The Enable input (\bar{E}) is active-LOW. When \bar{E} is HIGH, all of the outputs (\bar{Z}) are forced HIGH regardless of all other inputs. The 'AC/'ACT158 is the logic implementation of a 4-pole, 2-position switch where the position of the switch is determined by the logic levels supplied to the Select input.

A common use of the 'AC/'ACT158 is the moving of data from two groups of registers to four common output busses. The particular register from which the data comes is determined by the state of the Select input. A less obvious use is as a function generator. The 'AC/'ACT158 can generate four functions of two variables with one variable common. This is useful for implementing gating functions.

Logic Diagram



TL/F/9930-5

Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Absolute Maximum Rating (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage (V_{CC})	$-0.5V$ to $+7.0V$
DC Input Diode Current (I_{IK})	
$V_I = -0.5V$	-20 mA
$V_I = V_{CC} + 0.5V$	$+20\text{ mA}$
DC Input Voltage (V_I)	$-0.5V$ to $V_{CC} + 0.5V$
DC Output Diode Current (I_{OK})	
$V_O = -0.5V$	-20 mA
$V_O = V_{CC} + 0.5V$	$+20\text{ mA}$
DC Output Voltage (V_O)	$-0.5V$ to $V_{CC} + 0.5V$
DC Output Source or Sink Current (I_O)	$\pm 50\text{ mA}$
DC V_{CC} or Ground Current per Output Pin (I_{CC} or I_{GND})	$\pm 50\text{ mA}$
Storage Temperature (T_{STG})	-65°C to $+150^{\circ}\text{C}$
Junction Temperature (T_J)	
CDIP	175°C
PDIP	140°C

Note 1: Absolute maximum ratings are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. National does not recommend operation of FACT™ circuits outside databook specifications.

DC Characteristics for 'AC Family Devices

Symbol	Parameter	V_{CC} (V)	74AC		54AC	74AC	Units	Conditions
					$T_A = +25^{\circ}\text{C}$	$T_A = -55^{\circ}\text{C}$ to $+125^{\circ}\text{C}$		
			Typ	Guaranteed Limits				
V_{IH}	Minimum High Level Input Voltage	3.0 4.5 5.5	1.5 2.25 2.75	2.1 3.15 3.85	2.1 3.15 3.85	2.1 3.15 3.85	V	$V_{OUT} = 0.1\text{V}$ or $V_{CC} - 0.1\text{V}$
V_{IL}	Maximum Low Level Input Voltage	3.0 4.5 5.5	1.5 2.25 2.75	0.9 1.35 1.65	0.9 1.35 1.65	0.9 1.35 1.65	V	$V_{OUT} = 0.1\text{V}$ or $V_{CC} - 0.1\text{V}$
V_{OH}	Minimum High Level Output Voltage	3.0 4.5 5.5	2.99 4.49 5.49	2.9 4.4 5.4	2.9 4.4 5.4	2.9 4.4 5.4	V	$I_{OUT} = -50\text{ }\mu\text{A}$
		3.0 4.5 5.5		2.56 3.86 4.86	2.4 3.7 4.7	2.46 3.76 4.76	V	* $V_{IN} = V_{IL}$ or V_{IH} -12 mA $I_{OH} = 24\text{ mA}$ -24 mA
V_{OL}	Maximum Low Level Output Voltage	3.0 4.5 5.5	0.002 0.001 0.001	0.1 0.1 0.1	0.1 0.1 0.1	0.1 0.1 0.1	V	$I_{OUT} = 50\text{ }\mu\text{A}$
		3.0 4.5 5.5		0.36 0.36 0.36	0.50 0.50 0.50	0.44 0.44 0.44	V	* $V_{IN} = V_{IL}$ or V_{IH} 12 mA $I_{OL} = 24\text{ mA}$ 24 mA
I_{IN}	Maximum Input Leakage Current	5.5		± 0.1	± 1.0	± 1.0	μA	$V_I = V_{CC}, \text{GND}$

*All outputs loaded; thresholds on input associated with output under test.

Recommended Operating Conditions

Supply Voltage (V_{CC})	2.0V to 6.0V
'AC	4.5V to 5.5V
'ACT	
Input Voltage (V_I)	0V to V_{CC}
Output Voltage (V_O)	0V to V_{CC}
Operating Temperature (T_A)	
74AC/ACT	-40°C to $+85^{\circ}\text{C}$
54AC/ACT	-55°C to $+125^{\circ}\text{C}$
Minimum Input Edge Rate ($\Delta V/\Delta t$)	
'AC Devices	
V_{IN} from 30% to 70% of V_{CC}	
V_{CC} @ 3.3V, 4.5V, 5.5V	125 mV/ns
'ACT Devices	
V_{IN} from 0.8V to 2.0V	
V_{CC} @ 4.5V, 5.5V	125 mV/ns

DC Characteristics for 'AC Family Devices (Continued)

Symbol	Parameter	V _{CC} (V)	74AC		54AC	74AC	Units	Conditions
			T _A = +25°C		T _A = −55°C to +125°C	T _A = −40°C to +85°C		
			Typ	Guaranteed Limits				
I _{OLD}	†Minimum Dynamic Output Current	5.5			50	75	mA	V _{OLD} = 1.65V Max
I _{OHD}		5.5			−50	−75	mA	V _{OHD} = 3.85V Min
I _{CC}	Maximum Quiescent Supply Current	5.5		4.0	80.0	40.0	μA	V _{IN} = V _{CC} or GND

†Maximum test duration 2.0 ms, one output loaded at a time.

Note: I_{IN} and I_{CC} @ 3.0V are guaranteed to be less than or equal to the respective limit @ 5.5V V_{CC}.

I_{CC} for 54AC @ 25°C is identical to 74AC @ 25°C.

DC Characteristics for 'ACT Family Devices

Symbol	Parameter	V _{CC} (V)	74ACT		54ACT	74ACT	Units	Conditions
			T _A = +25°C		T _A = −55°C to +125°C	T _A = −40°C to +85°C		
			Typ	Guaranteed Limits				
V _{IH}	Minimum High Level Input Voltage	4.5 5.5	1.5 1.5	2.0 2.0	2.0 2.0	2.0 2.0	V	V _{OUT} = 0.1V or V _{CC} − 0.1V
V _{IL}	Maximum Low Level Input Voltage	4.5 5.5	1.5 1.5	0.8 0.8	0.8 0.8	0.8 0.8	V	V _{OUT} = 0.1V or V _{CC} − 0.1V
V _{OH}	Minimum High Level Output Voltage	4.5 5.5	4.49 5.49	4.4 5.4	4.4 5.4	4.4 5.4	V	I _{OUT} = −50 μA
		4.5 5.5		3.86 4.86	3.70 4.70	3.76 4.76	V	*V _{IN} = V _{IL} or V _{IH} I _{OH} −24 mA −24 mA
V _{OL}	Maximum Low Level Output Voltage	4.5 5.5	0.001 0.001	0.1 0.1	0.1 0.1	0.1 0.1	V	I _{OUT} = 50 μA
		4.5 5.5		0.36 0.36	0.50 0.50	0.44 0.44	V	*V _{IN} = V _{IL} or V _{IH} I _{OL} 24 mA 24 mA
I _{IN}	Maximum Input Leakage Current	5.5		±0.1	±1.0	±1.0	μA	V _I = V _{CC} , GND
I _{CCT}	Maximum I _{CC} /Input	5.5	0.6		1.6	1.5	mA	V _I = V _{CC} − 2.1V
I _{OLD}	†Minimum Dynamic Output Current	5.5			50	75	mA	V _{OLD} = 1.65V Max
		5.5			−50	−75	mA	V _{OHD} = 3.85V Min
I _{CC}	Maximum Quiescent Supply Current	5.5		4.0	80.0	40.0	μA	V _{IN} = V _{CC} or GND

*All outputs loaded; thresholds on input associated with output under test.

†Maximum test duration 2.0 ms, one output loaded at a time.

Note: I_{CC} for 54ACT @ 25°C is identical to 74ACT @ 25°C.

AC Electrical Characteristics

Symbol	Parameter	V _{CC} * (V)	74AC			54AC		74AC		Units	
			T _A = +25°C C _L = 50 pF			T _A = -55°C to +125°C C _L = 50 pF		T _A = -40°C to +85°C C _L = 50 pF			
			Min	Typ	Max	Min	Max	Min	Max		
t _{PLH}	Propagation Delay S to \bar{Z}_n	3.3 5.0	1.5 1.5	7.0 5.5	11.5 9.0	1.0 1.0	14.0 11.0	1.5 1.0	12.5 9.5	ns	
t _{PHL}	Propagation Delay S to \bar{Z}_n	3.3 5.0	1.5 1.5	7.0 5.5	11.5 9.0	1.0 1.0	14.0 11.0	1.5 1.5	12.5 10.0	ns	
t _{PLH}	Propagation Delay \bar{E} to \bar{Z}_n	3.3 5.0	1.5 1.5	7.5 6.0	12.0 9.5	1.0 1.0	15.0 12.0	1.5 1.5	13.0 10.5	ns	
t _{PHL}	Propagation Delay \bar{E} to \bar{Z}_n	3.3 5.0	1.5 1.5	7.0 5.5	11.0 8.5	1.0 1.0	14.0 10.0	1.5 1.0	12.0 9.5	ns	
t _{PLH}	Propagation Delay I _n to \bar{Z}_n	3.3 5.0	1.5 1.5	5.5 4.0	9.0 7.0	1.0 1.0	11.0 8.5	1.5 1.0	10.0 7.5	ns	
t _{PHL}	Propagation Delay I _n to Z_n	3.3 5.0	1.5 1.5	5.0 4.0	8.0 6.5	1.0 1.0	10.0 7.5	1.0 1.0	8.5 6.5	ns	

*Voltage Range 3.3 is 3.3V $\pm 0.3V$
Voltage Range 5.0 is 5.0V $\pm 0.5V$

AC Electrical Characteristics

Symbol	Parameter	V _{CC} * (V)	74ACT			54ACT		74ACT		Units	
			T _A = +25°C C _L = 50 pF			T _A = -55°C to +125°C C _L = 50 pF		T _A = -40°C to +85°C C _L = 50 pF			
			Min	Typ	Max	Min	Max	Min	Max		
t _{PLH}	Propagation Delay S to \bar{Z}_n	5.0	2.5	6.0	9.5	1.0	12.0	2.0	11.0	ns	
t _{PHL}	Propagation Delay S to \bar{Z}_n	5.0	1.5	5.5	9.0	1.0	11.5	1.5	10.0	ns	
t _{PLH}	Propagation Delay \bar{E} to \bar{Z}_n	5.0	1.5	5.5	9.5	1.0	11.0	1.5	10.5	ns	
t _{PHL}	Propagation Delay \bar{E} to \bar{Z}_n	5.0	1.5	5.5	9.5	1.0	11.0	1.5	10.5	ns	
t _{PLH}	Propagation Delay I _n to \bar{Z}_n	5.0	1.5	4.5	8.0	1.0	9.5	1.0	8.5	ns	
t _{PHL}	Propagation Delay I _n to Z_n	5.0	1.5	4.0	6.5	1.0	8.0	1.0	7.5	ns	

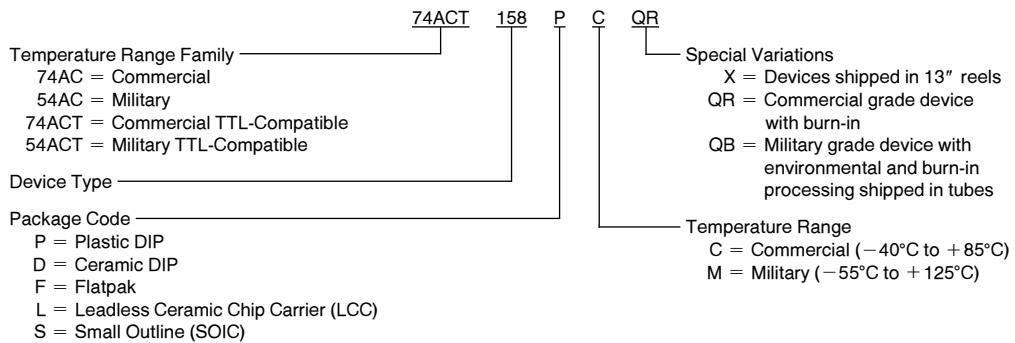
*Voltage Range 5.0 is 5.0V $\pm 0.5V$

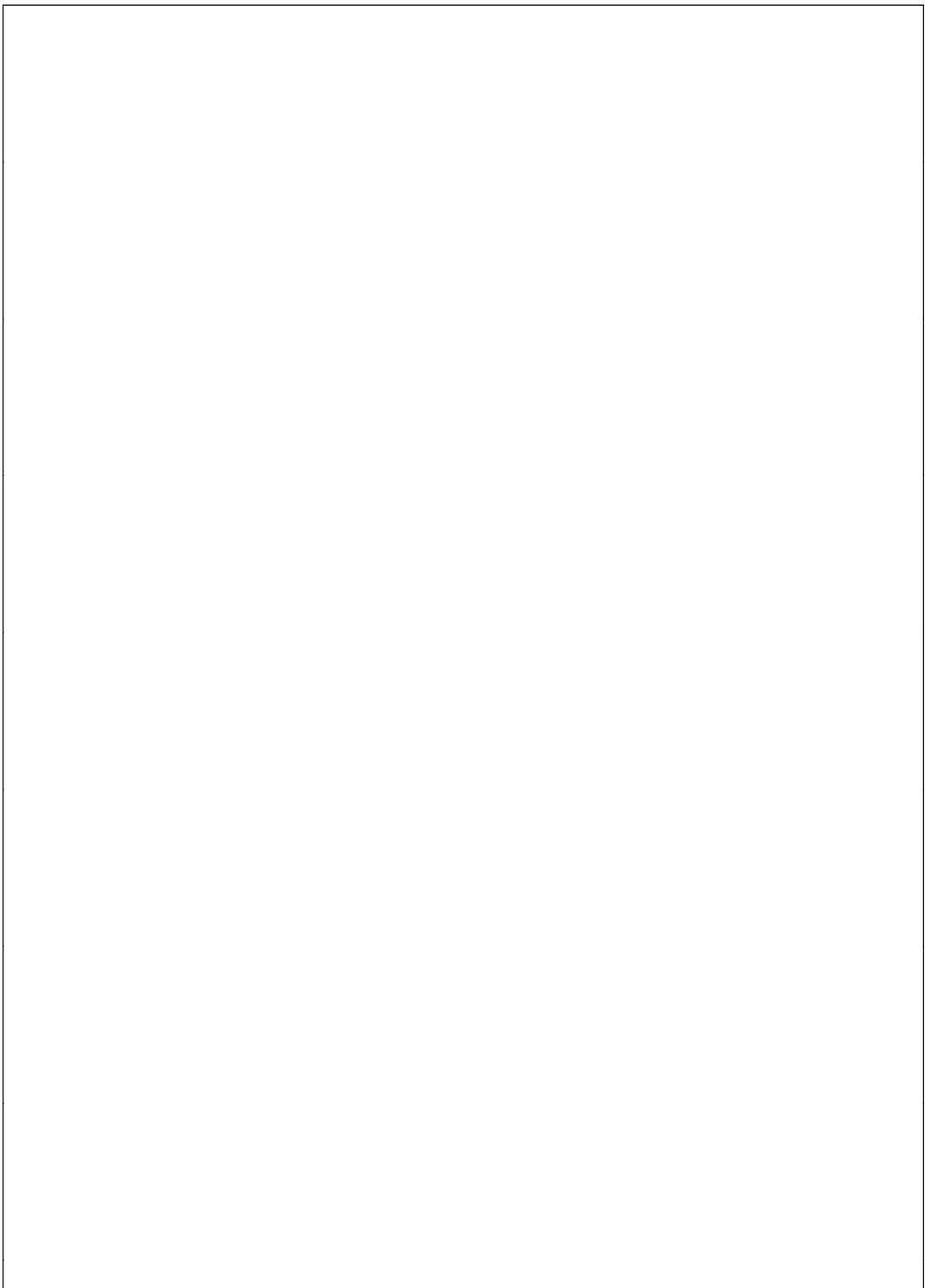
Capacitance

Symbol	Parameter	Typ	Units	Conditions
C _{IN}	Input Capacitance	4.5	pF	V _{CC} = OPEN
C _{PD}	Power Dissipation Capacitance	45.0	pF	V _{CC} = 5.0V

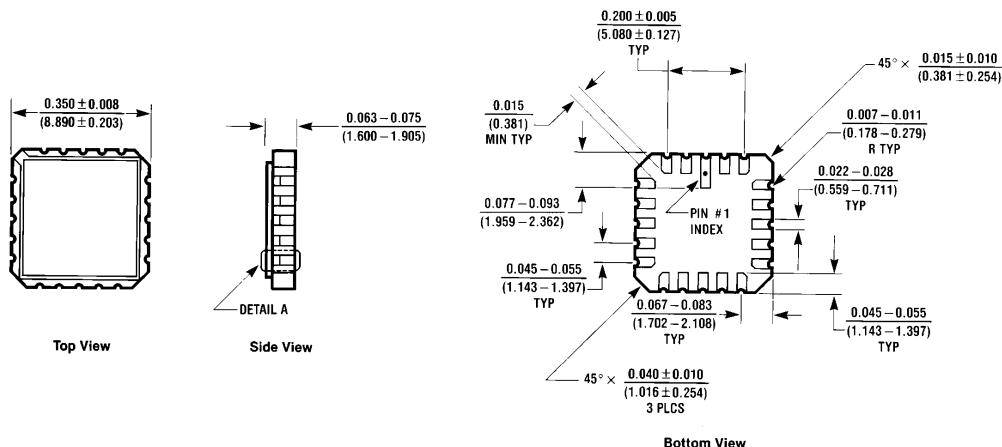
Ordering Information

The device number is used to form part of a simplified purchasing code where the package type and temperature range are defined as follows:



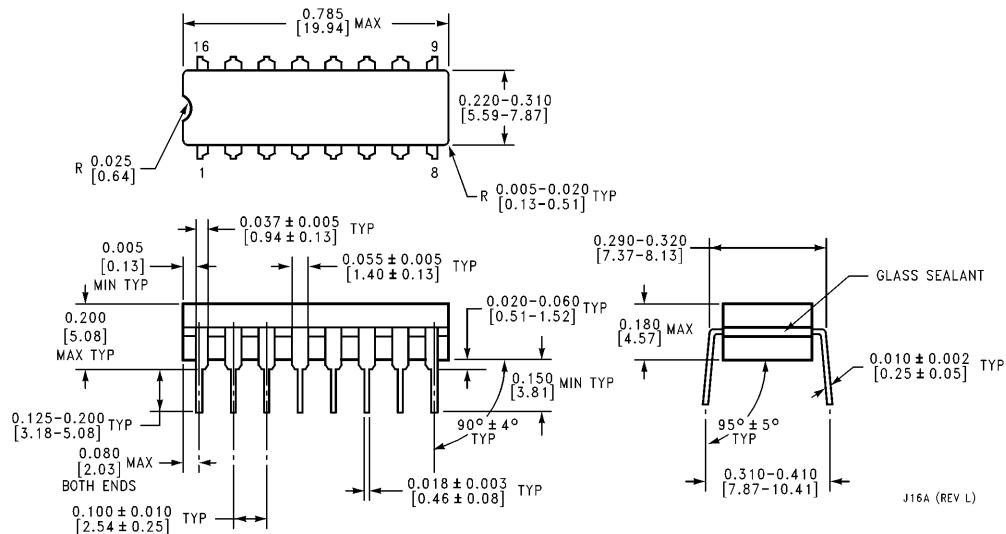


Physical Dimensions inches (millimeters)



20 Terminal Ceramic Leadless Chip Carrier (L)
NS Package Number E20A

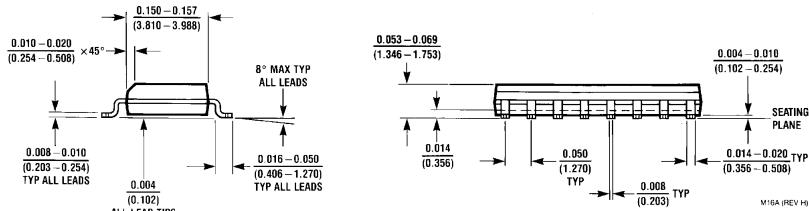
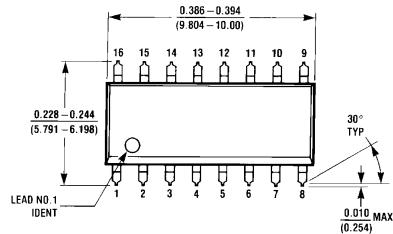
E20A (REV D)



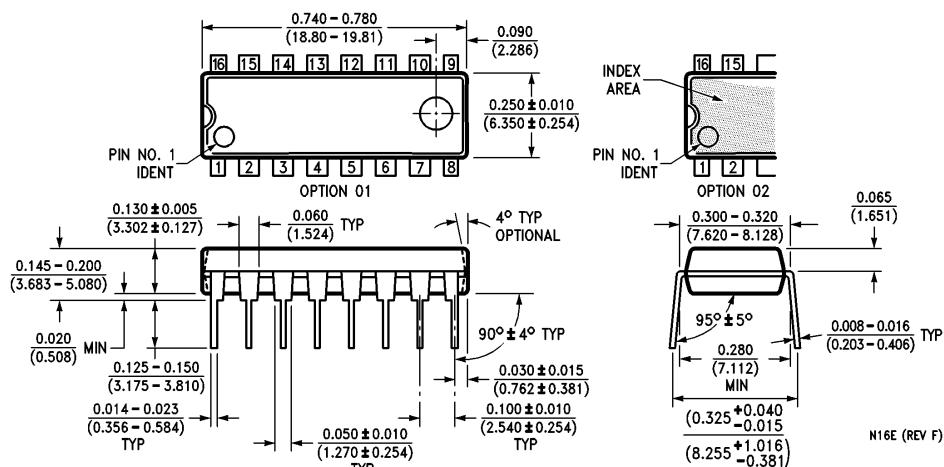
16 Lead Ceramic Dual-In-Line Package (D)
NS Package Number J16A

J16A (REV L)

Physical Dimensions inches (millimeters) (Continued)

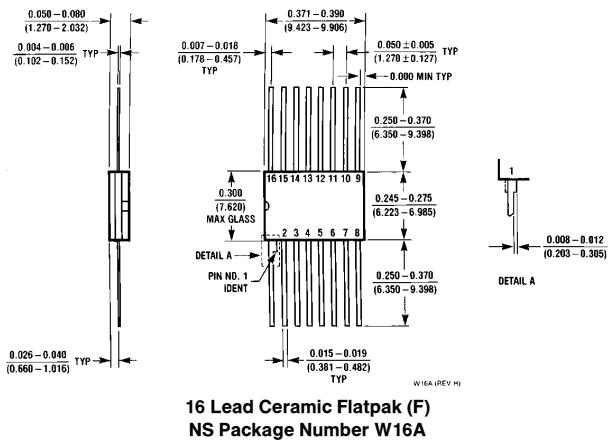


**16 Lead Small Outline Integrated Circuit (S)
NS Package Number M16A**



**16 Lead Plastic Dual-In-Line Package (P)
NS Package Number N16E**

Physical Dimensions inches (millimeters) (Continued)



16 Lead Ceramic Flatpak (F)
NS Package Number W16A

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